

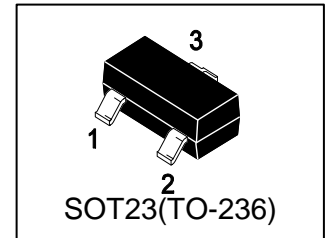
LBAV99LT1G

S-LBAV99LT1G

Dual Series Switching Diode

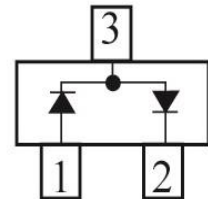
1. FEATURES

- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S- prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.



2. DEVICE MARKING AND ORDERING INFORMATION

| Device | Marking | Shipping |
|------------|---------|-----------------|
| LBAV99LT1G | A7 | 3000/Tape&Reel |
| LBAV99LT3G | A7 | 10000/Tape&Reel |



3. MAXIMUM RATINGS(Ta = 25°C)

| Parameter | Symbol | Limits | Unit |
|-------------------------------------|------------|--------|------|
| Reverse Voltage | VR | 75 | V |
| Forward Current | IF | 215 | mA |
| Peak Forward Surge Current | IFM(surge) | 500 | mA |
| Repetitive Peak Reverse Voltage | VRRM | 85 | V |
| Repetitive Peak Forward Current | IFRM | 500 | mA |
| Non-Repetitive Peak Forward Current | IFSM | | A |
| t=1μs | | 2 | |
| t=1ms | | 1 | |
| t=1s | | 0.5 | |

4. THERMAL CHARACTERISTICS

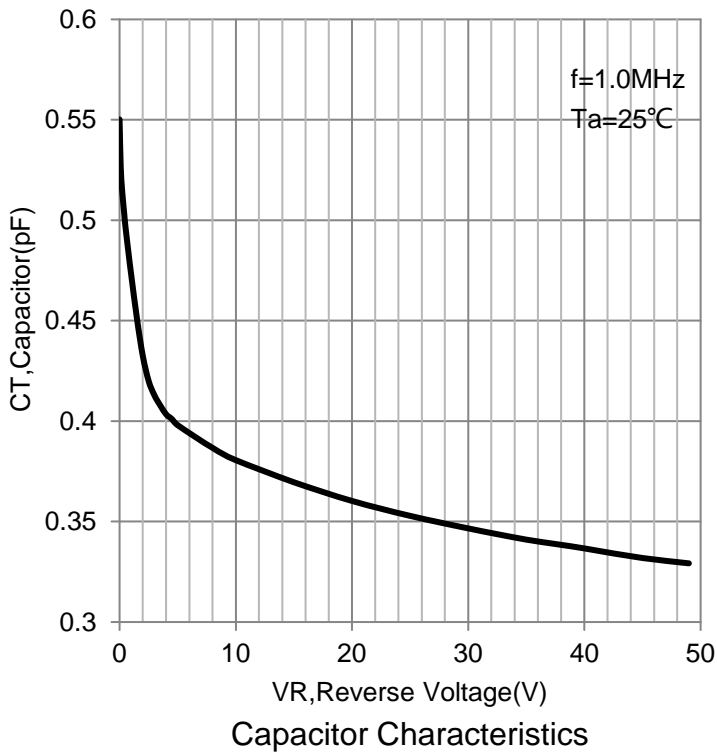
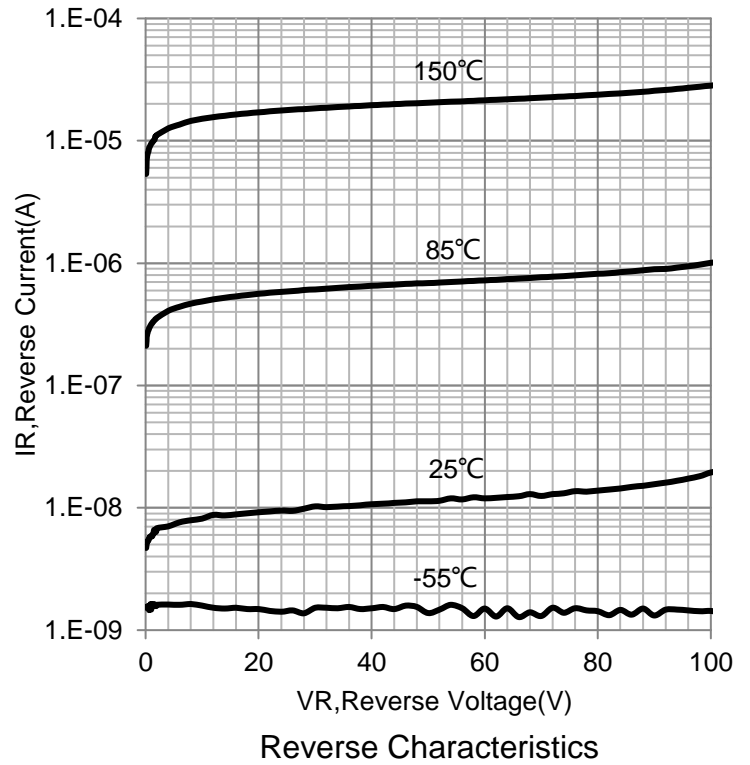
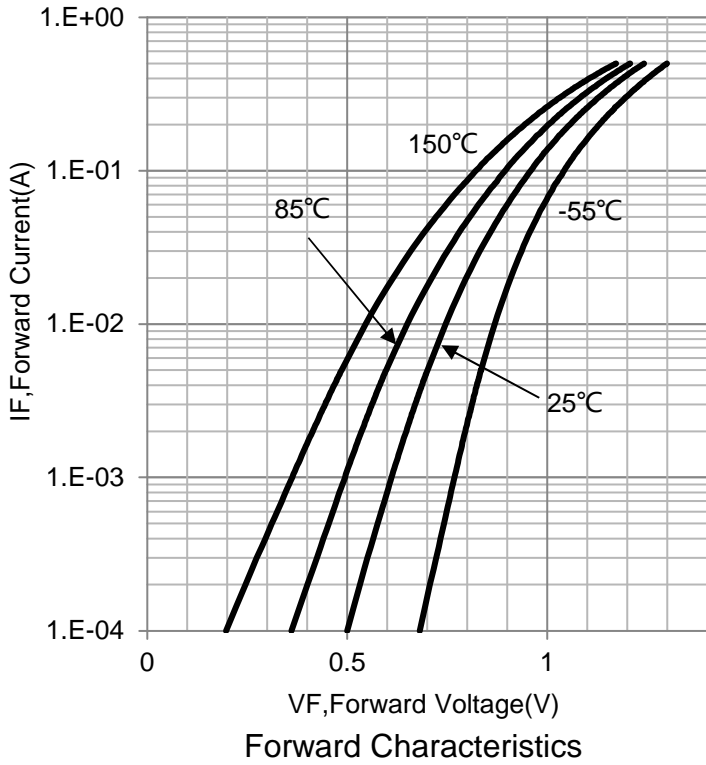
| Parameter | Symbol | Limits | Unit |
|---|----------|------------|-------------|
| Total Device Dissipation, FR-4 Board (Note 1) @ TA = 25°C Derate above 25°C | PD | 225 1.8 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient(Note 1) | ROJA | 556 | °C/W |
| Junction and Storage temperature | TJ, Tstg | -65 ~ +150 | °C |

1. FR-4 = 1.0×0.75×0.062 in.

5. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

| Characteristic | Symbol | Min. | Typ. | Max. | Unit |
|--|--------|------|------|------|------|
| Reverse Breakdown Voltage (I(BR)=100μA) | VBR | 70 | - | - | V |
| Forward Voltage (IF = 1.0 mA) | VF | - | - | 715 | mV |
| (IF = 10 mA) | | - | - | 855 | |
| (IF = 50 mA) | | - | - | 1000 | |
| (IF = 150 mA) | | - | - | 1250 | |
| Reverse Voltage Leakage Current (VR = 70V) | IR | - | - | 2.5 | μA |
| (VR = 70V, TJ = 150°C) | | - | - | 50 | |
| (VR = 25V, TJ = 150°C) | | - | - | 30 | |
| Diode Capacitance (VR = 0V, f = 1.0 MHz) | CD | - | - | 2.0 | pF |
| Reverse Recovery Time (IF=IR=10mA, RL =50Ω) | trr | - | - | 6.0 | ns |
| Forward Recovery Voltage (IF = 10 mA, tr = 20 ns) | VFR | - | - | 1.75 | V |

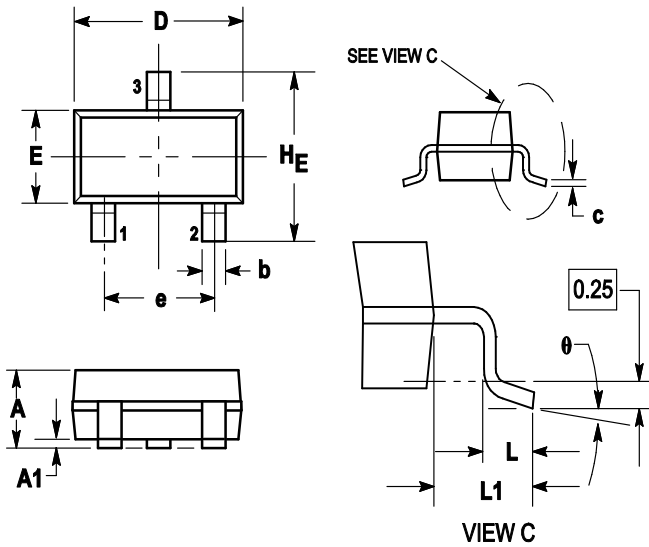
6. ELECTRICAL CHARACTERISTICS CURVES



7. OUTLINE AND DIMENSIONS

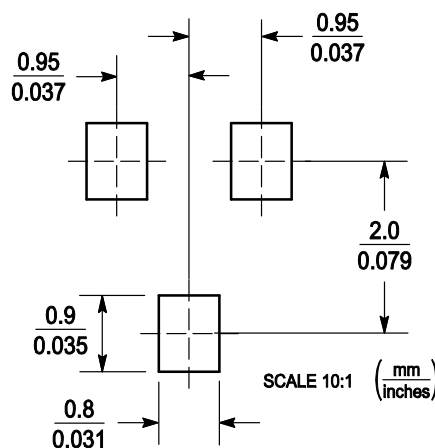
Notes:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



| DIM | MILLIMETERS | | | INCHES | | |
|-------|-------------|------|------|--------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.89 | 1 | 1.11 | 0.035 | 0.04 | 0.044 |
| A1 | 0.01 | 0.06 | 0.1 | 0.001 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.5 | 0.015 | 0.018 | 0.02 |
| c | 0.09 | 0.13 | 0.18 | 0.003 | 0.005 | 0.007 |
| D | 2.80 | 2.9 | 3.04 | 0.11 | 0.114 | 0.12 |
| E | 1.20 | 1.3 | 1.4 | 0.047 | 0.051 | 0.055 |
| e | 1.78 | 1.9 | 2.04 | 0.07 | 0.075 | 0.081 |
| L | 0.10 | 0.2 | 0.3 | 0.004 | 0.008 | 0.012 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.029 |
| HE | 2.10 | 2.4 | 2.64 | 0.083 | 0.094 | 0.104 |
| theta | 0° | --- | 10° | 0° | --- | 10° |

8. SOLDERING FOOTPRINT



单击下面可查看定价，库存，交付和生命周期等信息

[>>LRC\(乐山无线电\)](#)